

L Number	Hits	Search Text	DB	Time stamp
9	506	((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) (382/141).CCLS.	USPAT	2004/07/14 17:09
10	623		USPAT; US-PGPUB	2004/07/14 17:09
11	744	((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$))	USPAT; US-PGPUB	2004/07/14 17:38
12	10	((382/141).CCLS.) and (((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) )	USPAT; US-PGPUB	2004/07/14 17:10
13	2527	(356/600,601,625,390,448,237.1,237.2).CCLS.	USPAT; US-PGPUB	2004/07/14 17:10
14	316	(348/125,86).CCLS.	USPAT; US-PGPUB	2004/07/14 17:11
15	201	(250/559.34,550.29,559.19).CCLS.	USPAT; US-PGPUB	2004/07/14 17:11
16	855	(29/740).CCLS.	USPAT; US-PGPUB	2004/07/14 17:11
17	566	(73/104).CCLS.	USPAT; US-PGPUB	2004/07/14 17:11
18	13	(((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) and (((356/600,601,625,390,448,237.1,237.2).CCLS.) 6088108.URPN.	USPAT	2004/07/14 17:33
19	2		USPAT	2004/07/14 17:13
20	5	("4553843"   "5311304"   "5528371"   "5663799"   "5909285").PN.	USPAT	2004/07/14 17:13
21	7	5909285.URPN.	USPAT	2004/07/14 17:15
22	3	6141040.URPN.	USPAT	2004/07/14 17:16
23	10	5528371.URPN.	USPAT	2004/07/14 17:16
24	7	(((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) and ((348/125,86).CCLS.)	USPAT; US-PGPUB	2004/07/14 17:34
25	1	(((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) and ((250/559.34,550.29,559.19).CCLS.)	USPAT; US-PGPUB	2004/07/14 17:34
26	0	(((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) and ((29/740).CCLS.)	USPAT; US-PGPUB	2004/07/14 17:34
27	0	(((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) and ((73/104).CCLS.)	USPAT; US-PGPUB	2004/07/14 17:34
28	846	((pixel\$ same intensit\$) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$))	USPAT; US-PGPUB	2004/07/14 17:39
29	801	((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$))	USPAT; US-PGPUB	2004/07/14 17:36
30	57	(((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) not (((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) )	USPAT; US-PGPUB	2004/07/14 17:36
31	0	(((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) not (((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) and (((356/600,601,625,390,448,237.1,237.2).CCLS.) (348/125,86).CCLS.) (250/559.34,550.29,559.19).CCLS.) (29/740).CCLS.) ((73/104).CCLS.)	USPAT; US-PGPUB	2004/07/14 17:37

32	28	((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$)) ) and (((356/600,601,625,390,448,237.1,237.2).CCLS.) ((348/125,86).CCLS.) ((250/559.34,550.29,559.19).CCLS.) ((29/740).CCLS.) ((73/104).CCLS.))	USPAT; US-PGPUB	2004/07/14 17:37
33	123	((gray grey) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$))	EPO; JPO; DERWENT; IBM TDB	2004/07/14 17:39
34	66	((pixel\$ same intensit\$) same imag\$3) same (ic semiconduct\$ wafer (integrat\$ near circuit\$))	EPO; JPO; DERWENT; IBM TDB	2004/07/14 17:39